

## N-Channel Enhancement Mode Power MOSFET

<p><b>Description</b></p> <p>The GT1003D uses advanced trench technology to provide excellent <math>R_{DS(ON)}</math>, low gate charge. It can be used in a wide variety of applications.</p> <p><b>General Features</b></p> <ul style="list-style-type: none"> <li>● <math>V_{DS}</math> 100V</li> <li>● <math>I_D</math> (at <math>V_{GS} = 10V</math>) 3A</li> <li>● <math>R_{DS(ON)}</math> (at <math>V_{GS} = 10V</math>) &lt; 130mΩ</li> <li>● <math>R_{DS(ON)}</math> (at <math>V_{GS} = 4.5V</math>) &lt; 150mΩ</li> <li>● 100% Avalanche Tested</li> <li>● RoHS Compliant</li> </ul> <p><b>Application</b></p> <ul style="list-style-type: none"> <li>● Power switch</li> <li>● DC/DC converters</li> <li>● Synchronous Rectification</li> </ul>	<p>Schematic diagram</p> <p>Marking and pin assignment</p> <p>SOT-23-3L</p>		
<b>Device</b>	<b>Package</b>	<b>Marking</b>	<b>Packaging</b>
GT1003D	SOT-23-3L	GT1003D	3000pcs/Reel

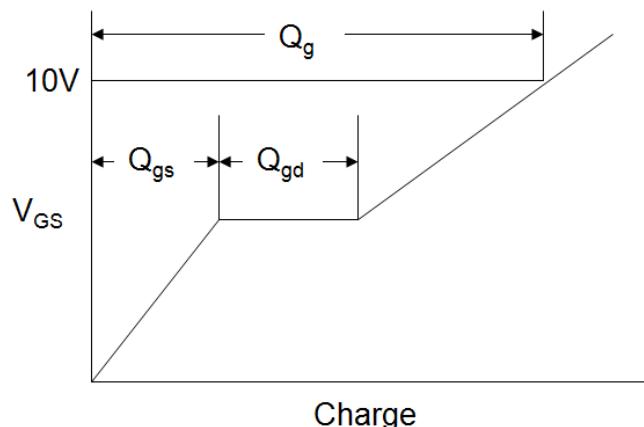
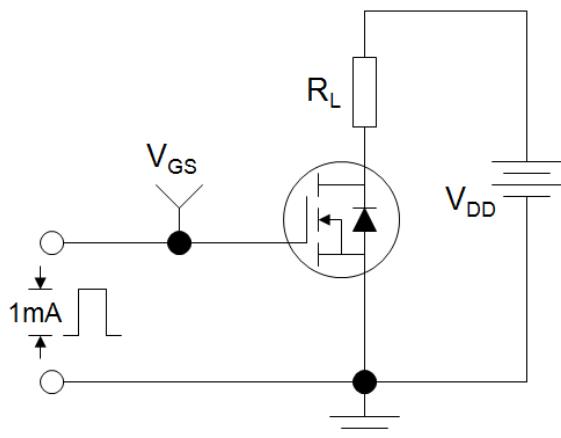
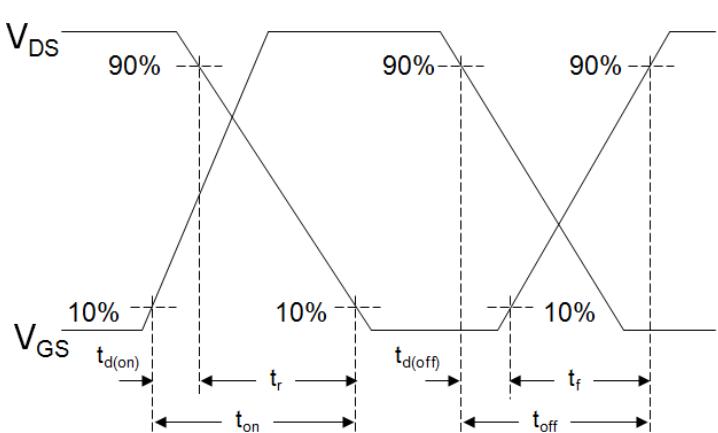
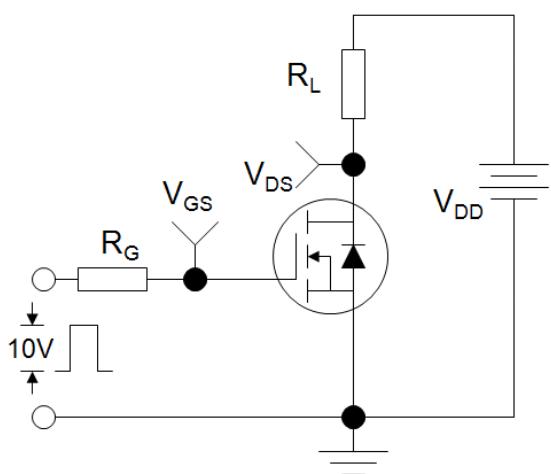
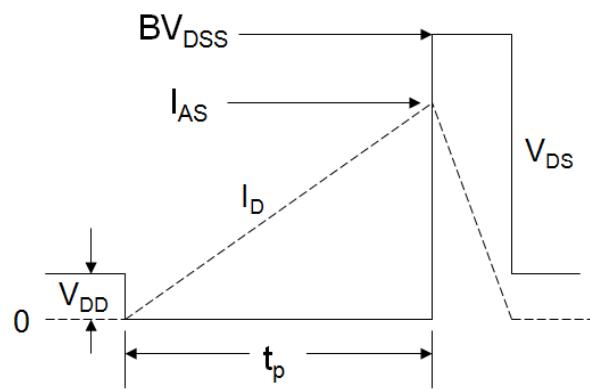
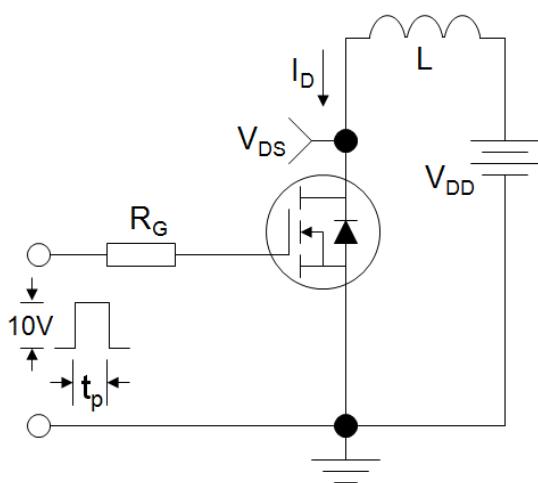
<b>Absolute Maximum Ratings</b> $T_C = 25^\circ\text{C}$ , unless otherwise noted			
Parameter	Symbol	Value	Unit
Drain-Source Voltage	$V_{DS}$	100	V
Continuous Drain Current	$I_D$	3	A
Pulsed Drain Current (note1)	$I_{DM}$	15	A
Gate-Source Voltage	$V_{GS}$	$\pm 20$	V
Single pulse avalanche energy (note3)	$E_{AS}$	3.2	mJ
Power Dissipation	$P_D$	2	W
Operating Junction and Storage Temperature Range	$T_J, T_{stg}$	-55 To 150	°C
<b>Thermal Resistance</b>			
Parameter	Symbol	Value	Unit
Thermal Resistance, Junction-to-Ambient	$R_{thJA}$	62.5	°C/W
Thermal Resistance, Junction-to-Case	$R_{thJC}$	7.2	°C/W

**Specifications**  $T_J = 25^\circ\text{C}$ , unless otherwise noted

Parameter	Symbol	Test Conditions	Value			Unit
			Min.	Typ.	Max.	
<b>Static Parameters</b>						
Drain-Source Breakdown Voltage	$V_{(\text{BR})\text{DSS}}$	$V_{\text{GS}} = 0\text{V}, I_D = 250\mu\text{A}$	100	--	--	V
Zero Gate Voltage Drain Current	$I_{\text{DSS}}$	$V_{\text{DS}} = 80\text{V}, V_{\text{GS}} = 0\text{V}, T_J = 25^\circ\text{C}$	--	--	1	$\mu\text{A}$
Gate-Source Leakage	$I_{\text{GSS}}$	$V_{\text{GS}} = \pm 20\text{V}$	--	--	$\pm 100$	nA
Gate-Source Threshold Voltage	$V_{\text{GS}(\text{th})}$	$V_{\text{DS}} = V_{\text{GS}}, I_D = 250\mu\text{A}$	1.2	1.8	2.6	V
Drain-Source On-Resistance	$R_{\text{DS}(\text{on})}$	$V_{\text{GS}} = 10\text{V}, I_D = 3\text{A}$	--	105	130	$\text{m}\Omega$
		$V_{\text{GS}} = 4.5\text{V}, I_D = 2\text{A}$	--	135	150	
<b>Dynamic Parameters</b>						
Input Capacitance	$C_{\text{iss}}$	$V_{\text{GS}} = 0\text{V}, V_{\text{DS}} = 50\text{V}, f = 1.0\text{MHz}$	--	212	--	$\text{pF}$
Output Capacitance	$C_{\text{oss}}$		--	27.5	--	
Reverse Transfer Capacitance	$C_{\text{rss}}$		--	1.6	--	
Total Gate Charge	$Q_g$	$V_{\text{DD}} = 50\text{V}, I_D = 3\text{A}, V_{\text{GS}} = 10\text{V}$	--	5.2	--	$\text{nC}$
Gate-Source Charge	$Q_{\text{gs}}$		--	1.6	--	
Gate-Drain Charge	$Q_{\text{gd}}$		--	1.2	--	
Turn-on Delay Time	$t_{\text{d}(\text{on})}$	$V_{\text{DD}} = 50\text{V}, I_D = 3\text{A}, R_G = 2\Omega$	--	16	--	$\text{ns}$
Turn-on Rise Time	$t_r$		--	3	--	
Turn-off Delay Time	$t_{\text{d}(\text{off})}$		--	19	--	
Turn-off Fall Time	$t_f$		--	2	--	
<b>Drain-Source Body Diode Characteristics</b>						
Continuous Body Diode Current	$I_s$	$T_C = 25^\circ\text{C}$	--	--	3	A
Body Diode Voltage	$V_{\text{SD}}$	$T_J = 25^\circ\text{C}, I_{\text{SD}} = 3\text{A}, V_{\text{GS}} = 0\text{V}$	--	--	1.2	V
Reverse Recovery Charge	$Q_{\text{rr}}$	$IF=3\text{A}, di/dt=100\text{A/us}$	--	27	--	$\text{nC}$
Reverse Recovery Time	$Tr_{\text{rr}}$		--	35	--	ns

**Notes**

1. Repetitive Rating: Pulse width limited by maximum junction temperature
2. Identical low side and high side switch with identical  $R_G$
3. EAS condition :  $T_J=25^\circ\text{C}$ ,  $V_{\text{DD}}=50\text{V}$ ,  $V_{\text{GS}}=10\text{V}$ ,  $L=0.5\text{mH}$ ,  $R_g=25\Omega$

**Gate Charge Test Circuit****EAS Test Circuit****Switch Time Test Circuit**

**Typical Characteristics**  $T_J = 25^\circ\text{C}$ , unless otherwise noted

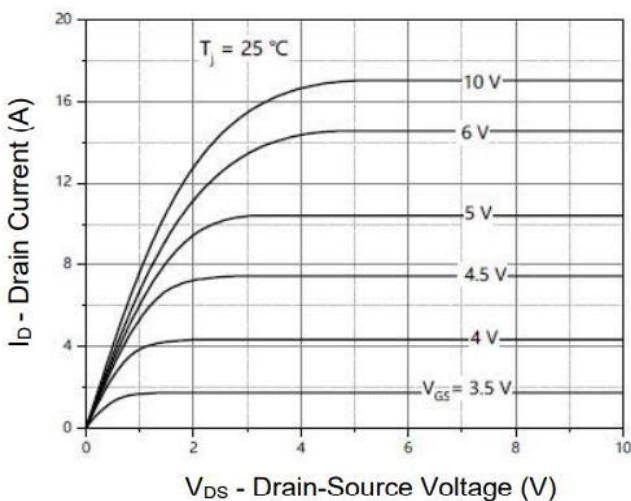


Figure1. Output Characteristics

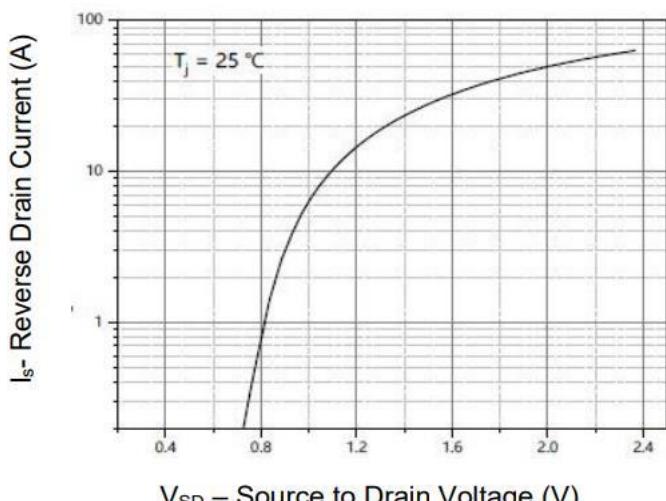


Figure2. Transfer Characteristics

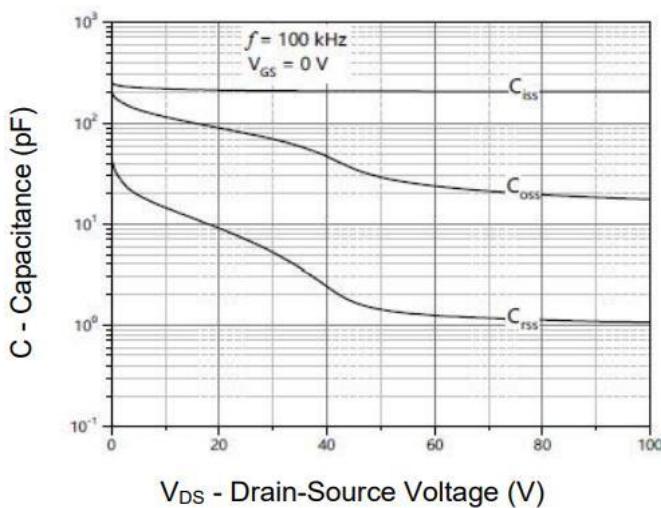


Figure3. Capacitance Characteristics

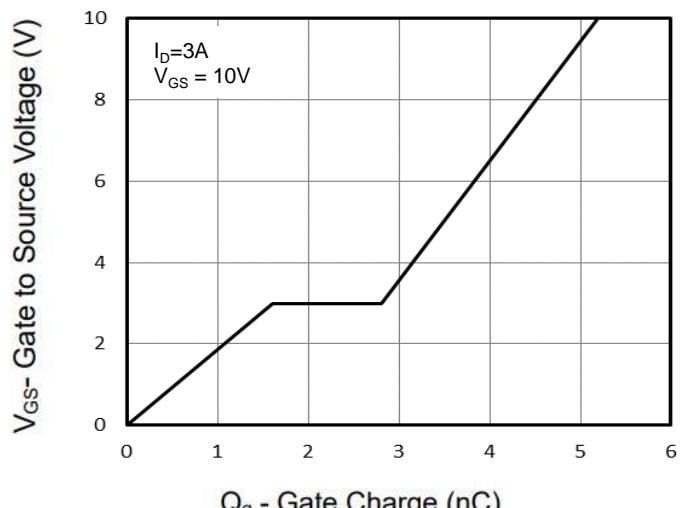


Figure4. Gate Charge

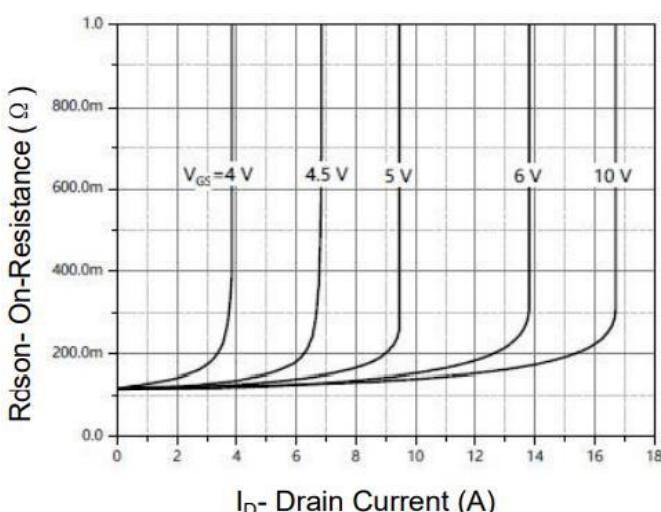


Figure5. Drain-Source on Resistance

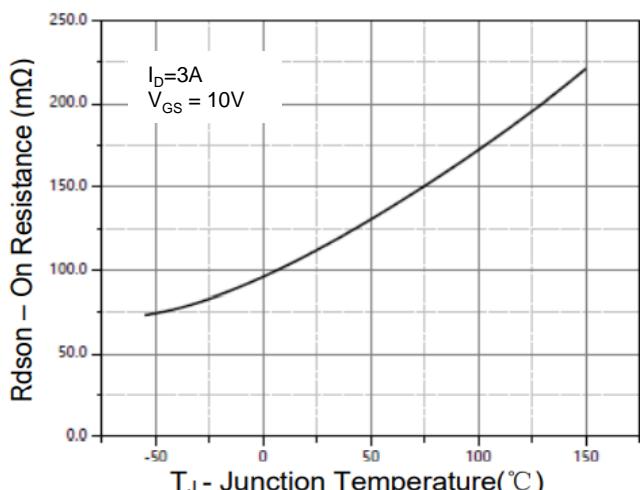
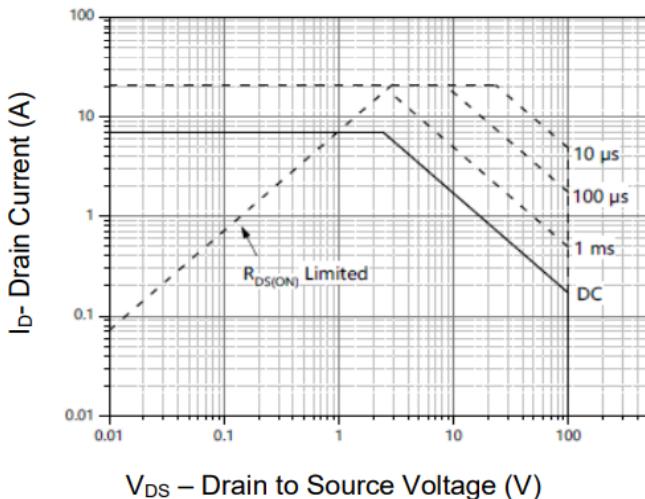


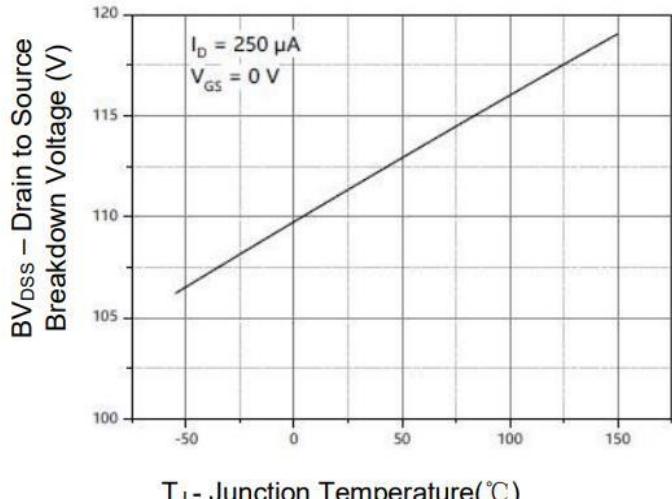
Figure6. Drain-Source on Resistance

**Typical Characteristics**  $T_J = 25^\circ\text{C}$ , unless otherwise noted



$V_{DS}$  – Drain to Source Voltage (V)

Figure 7. Safe Operation Area



$T_J$  - Junction Temperature (°C)

Figure 8. Drain-source breakdown voltage

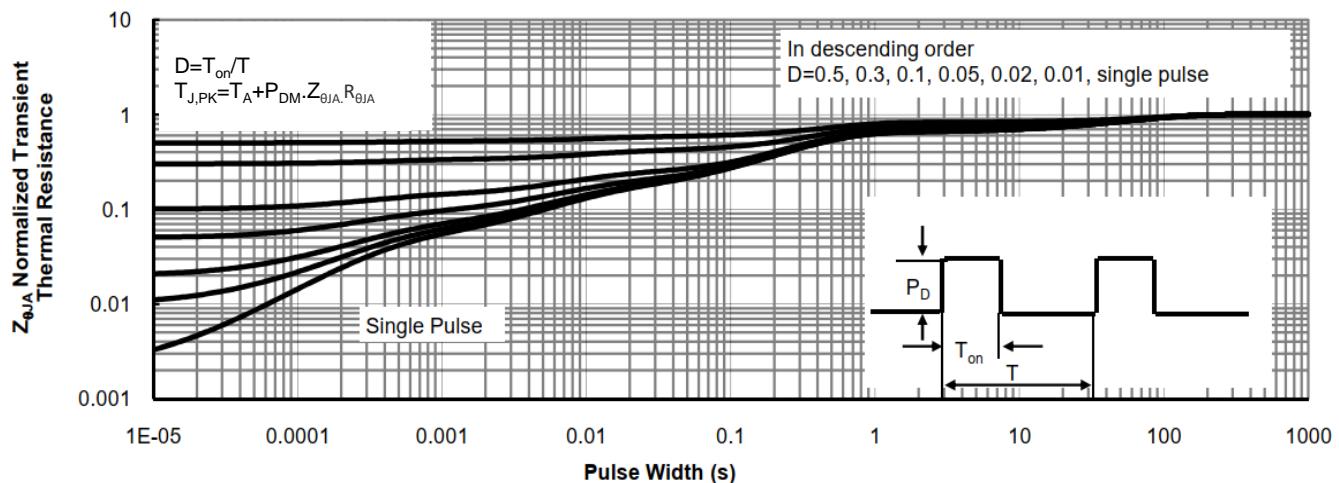
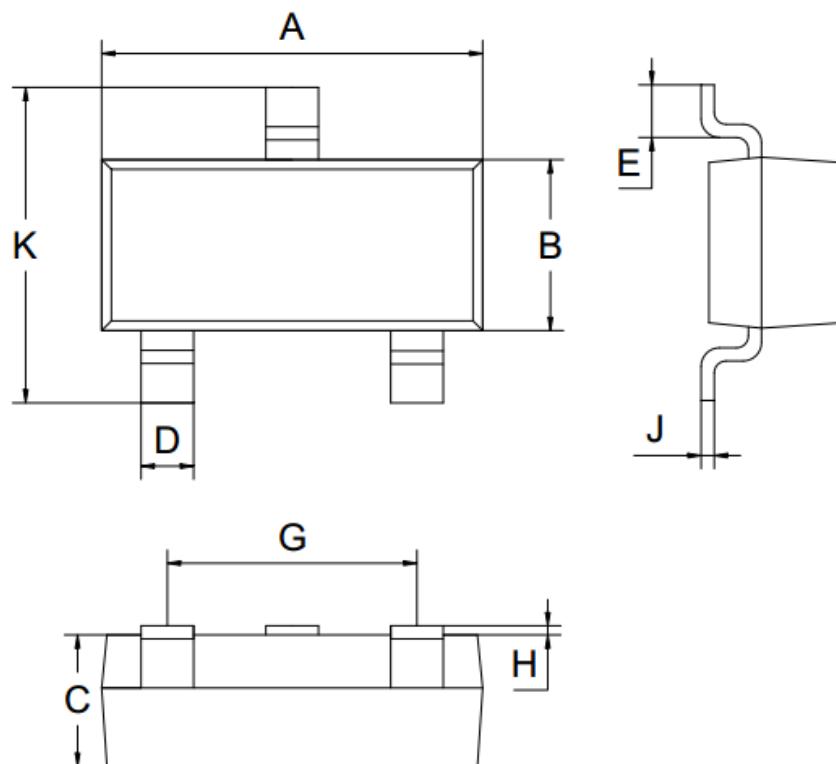


Figure 9. Transient thermal impedance

## SOT-23-3L Package Information



Symbol	Dimensions in Millimeters		
	MIN.	NOM.	MAX.
A	2.80	2.90	3.00
B	1.50	1.60	1.70
C	1.00	1.10	1.20
D	0.30	0.40	0.50
E	0.25	0.40	0.55
G	1.90		
H	0.00	-	0.10
J	0.047	0.127	0.207
K	2.60	2.80	3.00
All Dimensions in mm			